

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
DANIEL C. HAYES	06/09/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	YESCORP INC.
<b>Street Address:</b>	P.O. BOX 1205
<b>City:</b>	VALPARAISO
<b>State/Country:</b>	INDIANA
<b>Postal Code:</b>	46384
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	11975261
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	A8-2545
<b>NAME OF SUBMITTER:</b>	DOMENICA N.S. HARTMAN
<b>SIGNATURE:</b>	/Domenica N.S. Hartman/
<b>DATE SIGNED:</b>	06/09/2014
<b>Total Attachments: 1</b>	
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ASSIGNMENT

This AGREEMENT is by and between:

Daniel C. Hayes, a citizen of the United States, residing at 102 Kinsale Ave., Valparaiso, IN 46384, referred to as the INVENTOR below; and

YESCORP INC., (YESCORP) a corporation of Indiana, having a place of business at PO Box 1205, Valparaiso, IN 46384.

1. This AGREEMENT describes an understanding regarding a(n)

**INFORMATION MANAGEMENT AND COMMUNICATIONS SYSTEM FOR COMMUNICATION BETWEEN PATIENTS AND HEALTHCARE PROVIDERS**

described in:

X U.S. Utility Application Serial No. 11/975,261 with a Filing Date of October 18, 2007, referred to as the "INVENTION" below.

     Attorney Docket No.           , referred to as the "INVENTION" below, for which the INVENTOR are about to make application for Letters Patent of the United States of America.

2. The INVENTOR and YESCORP agree to the following:

- a. In exchange for good and valuable consideration, receipt of which is acknowledged by this AGREEMENT, the INVENTOR formally assigns to YESCORP all right, title and interest, in all countries, in the INVENTION, as well as all of his right, title and interest in any divisions or continuations of the United States patent application, and all Patents, United States and foreign, granted upon any applications which cover the INVENTION, and any reissues or extensions of any patent which may issue from the United States patent application.
- b. The INVENTOR authorizes and requests the Commissioner of Patents and Trademarks to issue all patents on the United States patent application to YESCORP as the assignee of the INVENTION.
- c. The INVENTOR shall cooperate in good faith to provide information and assistance in support of the filing and prosecution of any patent application filed on the INVENTION, as well as any legal proceedings relating thereto, and will sign all instruments and documents and provide such assistance which in the judgment of YESCORP is necessary to vest and protect the legal title assigned by this AGREEMENT.

Inventor's Signature:   
Inventor's Full Name: Daniel C. Hayes  
Inventor's Post Office Address: 102 Kinsale Ave., Valparaiso, IN 46385

Date: 6-9-2014  
Citizenship: United States